## Zhongxu Wang

List of Publications by Year in descending order

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933447 1372567 23 541 10 10 citations g-index h-index papers 23 23 23 378 docs citations times ranked citing authors all docs

#	Article	IF	CITATIONS
1	A Reference Submodule Based Capacitor Condition Monitoring Method for Modular Multilevel Converters. IEEE Transactions on Power Electronics, 2020, 35, 6691-6696.	7.9	25
2	Artificial Intelligence-Aided Thermal Model Considering Cross-Coupling Effects. IEEE Transactions on Power Electronics, 2020, 35, 9998-10002.	7.9	29
3	A Guideline for Reliability Prediction in Power Electronic Converters. IEEE Transactions on Power Electronics, 2020, 35, 10958-10968.	7.9	91
4	Capacitor Condition Monitoring Based on the DC-Side Start-Up of Modular Multilevel Converters. IEEE Transactions on Power Electronics, 2020, 35, 5589-5593.	7.9	33
5	Mission Profile-Based System-Level Reliability Prediction Method for Modular Multilevel Converters. IEEE Transactions on Power Electronics, 2020, 35, 6916-6930.	7.9	50
6	System-Level Thermal Modeling of a Modular Multilevel Converter. , 2020, , .		4
7	A Simplification Method for Power Device Thermal Modeling With Quantitative Error Analysis. IEEE Journal of Emerging and Selected Topics in Power Electronics, 2019, 7, 1649-1658.	5.4	14
8	Simplified Multi-time Scale Thermal Model Considering Thermal Coupling in IGBT Modules. , 2019, , .		16
9	Condition Monitoring Method for Submodule Capacitor in Modular Multilevel Converter. , 2019, , .		3
10	Computational-Efficient Thermal Estimation for IGBT Modules Under Periodic Power Loss Profiles in Modular Multilevel Converters. IEEE Transactions on Industry Applications, 2019, 55, 4984-4992.	4.9	13
11	Reliability Modeling of Power Electronic Converters: A General Approach. , 2019, , .		29
12	Condition Monitoring for Submodule Capacitors in Modular Multilevel Converters. IEEE Transactions on Power Electronics, 2019, 34, 10403-10407.	7.9	38
13	A Viable Mission Profile Emulator for Power Modules in Modular Multilevel Converters. IEEE Transactions on Power Electronics, 2019, 34, 11580-11593.	7.9	17
14	System-Level Power Loss Evaluation of Modular Multilevel Converters., 2019,,.		4
15	Simplified Thermal Modeling for IGBT Modules With Periodic Power Loss Profiles in Modular Multilevel Converters. IEEE Transactions on Industrial Electronics, 2019, 66, 2323-2332.	7.9	85
16	Mission Profile Based Adaptive Carrier Frequency Control for Modular Multilevel Converters for Medium Voltage Applications. , 2019, , .		0
17	Simplified Estimation of the Junction Temperature Fluctuation at the Output Frequency for IGBT Modules in Modular Multilevel Converters. , $2018$ , , .		2
18	Balanced Conduction Loss Distribution among SMs in Modular Multilevel Converters. , 2018, , .		11

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#	Article	IF	CITATION
19	Submodule Level Power Loss Balancing Control for Modular Multilevel Converters. , 2018, , .		11
20	Impact of the Thermal-Interface-Material Thickness on IGBT Module Reliability in the Modular Multilevel Converter. , $2018,  ,  .$		3
21	The impact of mission profile models on the predicted lifetime of IGBT modules in the modular multilevel converter., 2017,,.		14
22	An analytical essential switching loss estimation method for modular multilevel converters with nearest level modulation. , 2017, , .		5
23	Impact of lifetime model selections on the reliability prediction of IGBT modules in modular multilevel converters., 2017,,.		44